







Features

- Precision voltage monitor for 1.8V,2.5V,3.3V power supplies
- RESET remains valid with V_{CC} as low as 1V
- 140ms minimum reset pulse width available
- 3µA typical supply current
- Available in 3-pin SOT23-3L package

Description

The VR809T is a low-power microprocessor (μP) supervisory circuit used to monitor power supplies in microprocessor and digital systems. Low supply current makes the VR809T ideal for use in portable equipment. The device comes in a 3-pin SOT23-3L package.

The VR809T provides excellent circuit reliability and low BOM cost by eliminating external

components and adjustments when used with 5V-powered or 3V-powered circuits. The VR809T also provides a debounced manual reset input. The VR809T provide an active low reset signal while the VR809T provides an active high signal output. The function of this device is to assert a reset if either the power supply drops below a designed reset threshold level is forced low. The reset comparator is designed to ignore fast transients on $V_{\rm CC}$. Reset

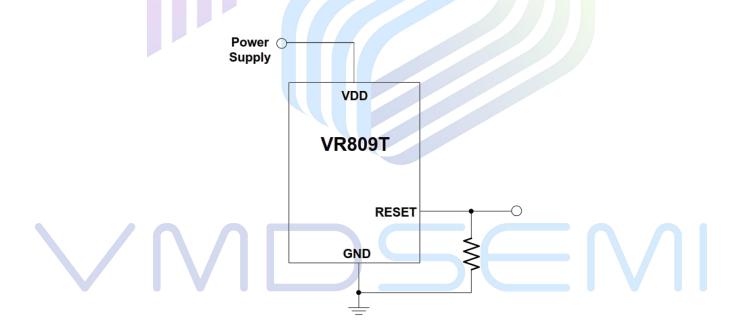
thresholds are available for operation with a variety

Applications

of supply voltages.

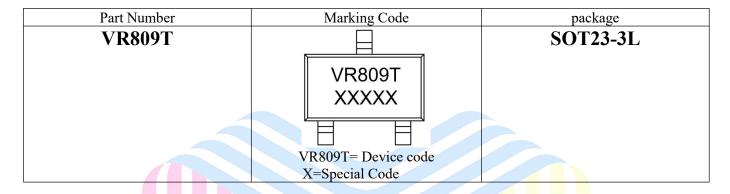
- Computer
- Controllers
- Intelligent Instruments
- Critical μP and μC Power Monitoring
- Portable/Battery-Powered Equipment

Typical Application Circuit

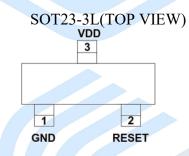




Ordering and Marking Information



Pin configuration



Pin Description

Pin No.	Name	Function
1	GND	IC Ground Pin.
2	RESET	\overline{RESET} goes low if V_{CC} falls below the reset threshold and remains asserted for one reset timeout period after V_{CC} exceeds the reset threshold.
3	V_{CC}	Power Supply Input.

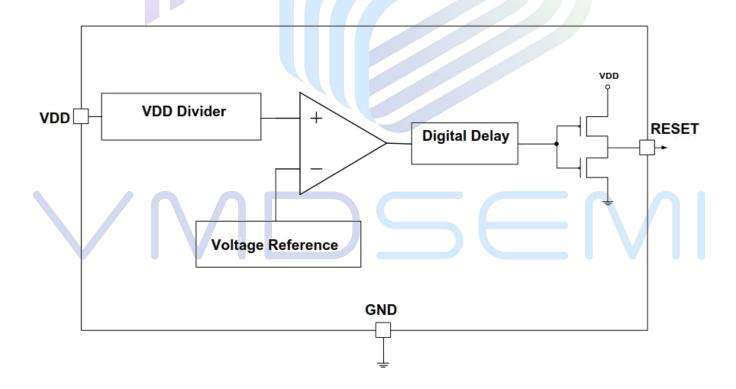




Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Terminal Voltage(V _{CC})	V_{CC}	-0.3 to 6.0V	V
Input Current(V _{CC})	V_{CC}	20	mA
Output Current(RESET)		20	mA
ESD Rating		3	KV
Lead Temperature(soldering, 10sec)		300	°C
Junction Temperature		150	°C
Storage Temperature		-65 to 150	°C
SOT23-3L Package Thermal Resistance, θJA		250	°C/W
SOT23-3L Package Thermal Resistance, θJC		115	°C/W
HBM		±4000	V
CDM		±1000	V

Functional Diagram



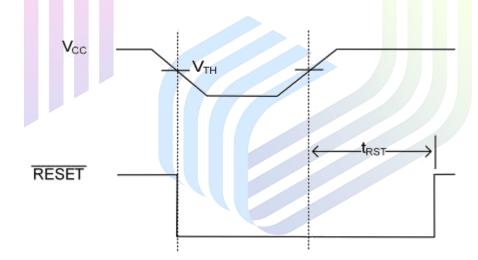


Electrical Characteristics

VR809 X (TA = ± 25 °C unless otherwise stated)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Operation Voltage Range	V_{CC}	1		5.5	V	T_A =-40°C to 85°C
Supply Current	Icc		2.2	8	μΑ	V _{CC} =1.8V, no load
Reset Voltage Threshold	V_{TH}	1.589	1.63	1.671	V	
Reset Timeout Period	t _{RST}	140		560	ms	
	V_{OH}	$0.8 \times V_{CC}$			V	I _{SOURECE} =500μA
PEGET O V. Iv	V _{OL}			0.3	V	$V_{CC}=V_{TH}$ min, $I_{SINK}=1.2mA$
RESET Output Voltage				0.3	V	V _{CC} >1V,I _{SINK} =50μA,

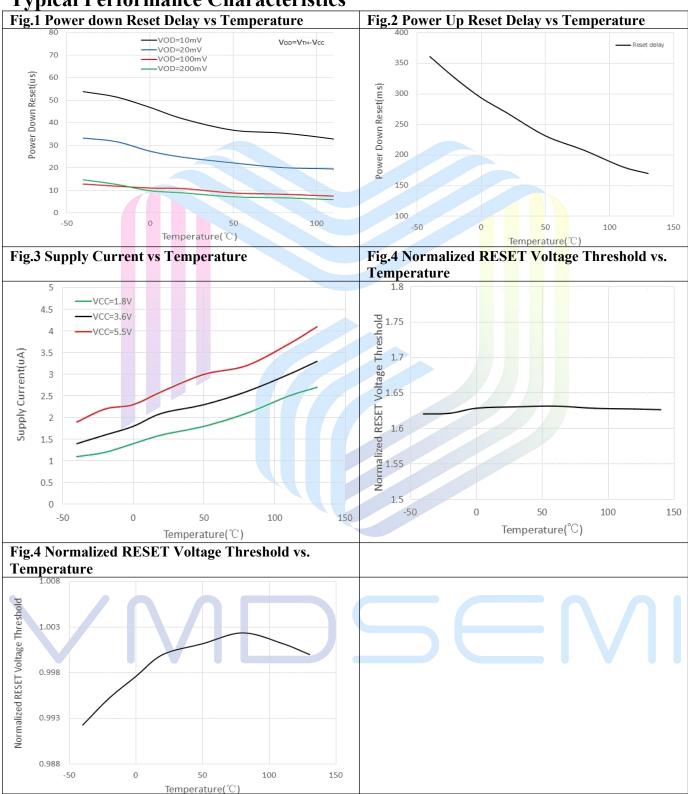
Timing Diagram







Typical Performance Characteristics





Applications Information

Microprocessor Reset

The RESET pin is asserted whenever V_{CC} falls below the reset threshold voltage. The RESET pin remains asserted for a period of 140ms after V_{CC} has risen above the reset threshold voltage. The reset and powers up in a known condition after a power failure. RESET will remain valid with V_{CC} as low as 1V.

V_{CC} Transients

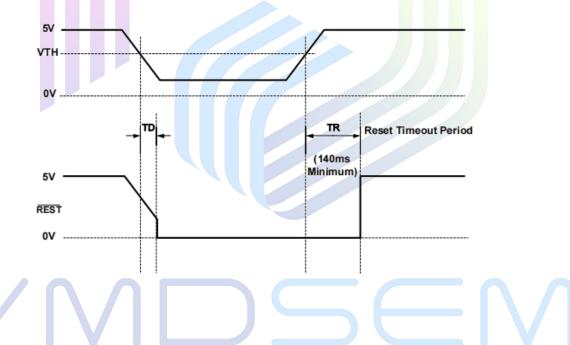
The VR809T is relatively immune to negative-going $V_{\rm CC}$ glitches below the reset threshold. Typically, a negative-going transient 125mV below the reset threshold with a duration of 20 μ s or less will not cause a reset.

Interfacing to Bidirectional Reset Pins

The VR809T can interface with μPs with bidirectional reset pins by connecting a $4.7k\Omega$ resistor in series with the VR809T output and the μP reset pin.

Reset Valid at Low Voltage

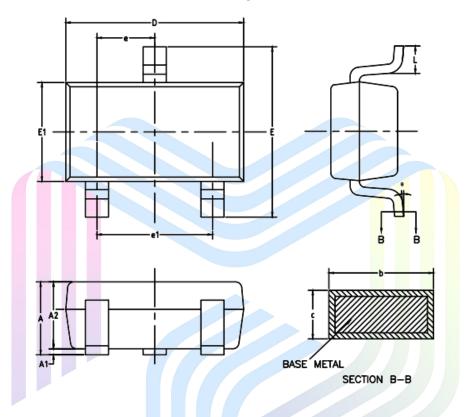
A resistor can be added from the RESET pin to ground to ensure the RESET output remains low with VCC down to 0V. A $100k\Omega$ resistor connected from the RESET to ground is recommended. The size of the resistor should be large enough not to load the output excessively and small enough to pull-down any stray leakage currents.





Mechanical Dimensions

SOT23-3L Package Information



SYMBOL	MILLIMETER			
STWIDGE	MIN	MAX		
A	0.9	1.45		
A1	0	0.15		
A2	0.9	1.3		
	0.28	0.5		
C	0.1	0.23		
D	2.82	3.05		
E	2.6	3.0		
E1	1.5	1.75		
е	0.95BSC			
e1	1.8	2		
L	0.3	0.6		
θ	0°	8°		



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